

# ONYX® 2" DC / IC Target, MAG.II

## **US Specifications**

	OS Specifications					
C	onstruction					
	Anode		304 Stainless Steel			
	Cathode Body		OFHC Copper			
	Insulator		CTFE			
С	ooling Requiren	nents				
	Flow Rate at Maximum Power		0.75 GPM			
	Maximum Input	t Pressure, Open Drain	60 psi			
	Maximum Inpu	t Temperature	68 °F			
Di	imensions					
	Α	3.750"	⊬————B————————————————————————————————			
	В	4.444"				
	С	1.000"				

## General

Magnetic Enhancement	Permanent (NdFeB) Encapsulated
Maximum Temperature	212 °F
Source to Substrate Distance	2.000" - 12.000"
Weight, Approximate Without Options	8 lb

# Maximum Sputtering Power \*

Cathode Voltage	100 - 1500 Volts
Direct Cooled Mode, DC	1.5 kW
Direct Cooled Mode, RF	900 Watts
Discharge Current	0.1 - 3 Amps
Indirect Cooled Mode, DC	1 kW
Indirect Cooled Mode, RF	600 Watts
Operating Pressure	0.5 - 50 mTorr

### Mounting, Standard

N Connector, External Threads
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HN Connector, External Threads
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## Target

Cooling	Direct / Indirect
Diameter	2.000" / 3.262"
Form	Circular / Planar
Thickness, Magnetic	0.125" Ni
Thickness, Non-Magnetic	0.250" / 0.448"

## Specifications Disclaimer

- All Angstrom Sciences NdFeB magnets are totally encapsulated and protected from degradation by water.
- · All sources are available in external configurations.
- Magnetic material calculations are optimized with Nickel targets.
- \* Maximum power for cathode only, a target material's properties, such as, thermal and electrical conductivity may limit the maximum process power level.
- Some custom-engineered and specialty magnetrons may not meet standard specifications.
- Specifications are subject to change without notice.
- · Thickness will vary depending upon coercivity of target material.
- Typical performance. Results may vary with process parameters such as pressure, flow rate, target material, and substrate rotation, etc.

Please contact us for specifications regarding your application.

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